

EAST: [10884310 power module with carbon tubes.wsp:1]

File View Edit Tools Window Help

Pending

Active

- L1: (11885978)c
- L2: (1186837)carbon
- L3: (3485868) (tub\$5 post pin needle)
- L4: (289410) (heatsink (heat thermal\$2) near (sink\$4 spread\$3 dissipat\$3 conducti
- L5: (287865) power near 2 (semiconductor device module element component)
- L6: (48075) (1 2) near 2 3
- L7: (8800) 4 with 5
- L9: (4) 8 and 8
- L10: (14) "SEMIKRON ELEKTRONIK".as.
- L11: (1) "DE 10103340"
- L12: (121) 6 with 4
- L13: (5) 8 and 2
- L8: (1811) 7 with 3

Failed

Saved

- (1) 09/948877
- (1736) "KONINKLIJKE PHILIPS".as.
- (1) 10/682110
- (1) 10/684310
- (15394) (nano quantum submicron sub adj micron) adj (wire tube rod dot) structure
- (2506848) tub\$5 post
- (1186405)carbon
- (333785) (heatsink (heat thermal\$2) near (sink\$4 spread\$3 dissipat\$3 conducting c
- (1992139) (microchio micro adi chio chio inteorated adi circuit die ic semiconductor

USPAT:US POPUD: EPO: JPO: DERWENT: IBM: TDO

Default operator: OR

7 with 3

Aug 2004

	U	I	inventor	Document#	Issue	P	Title	Current	Current	Current	Retrieval	S	C	P	Image	Doc	P
1			Heilbronn, R	US 2004010	20040	1	Power semiconductor module	257/708				R	F	F	F	F	US 200401
2			Conte, Rober	US 2004015	20040	1	Pin fin heat sink for power electronic applica	361/709				R	F	F	F	F	US 200401
3			Belady, Chris	US 2004015	20040	9	POWER MODULE FOR MULTI-CHIP PRINTED	361/704-361/715				R	F	F	F	F	US 200401
4			Rodrigues, Ju	US 2004014	20040	6	Electric connection arrangement for electron	439/76				R	F	F	F	F	US 200401
5			Wright, Doug	US 2004003	20040	1	Bench top tubing sealer	218/221				R	F	F	F	F	US 200400
6			Sase, Takash	US 2003023	20031	2	Power supply device	323/282				R	F	F	F	F	US 200302
7			Weimer, Alan	US 2003018	20031	1	Solar-thermal fluid-wall reaction processing	48/187R-48/118				R	F	F	F	F	US 200301
8			Branch, Scot	US 2003016	20030	1	Modular heat sinks	385/82				R	F	F	F	F	US 200301
9			Tong, Qin-Yi	US 2003014	20030	2	Method of epitaxial-like wafer bonding at lo	257/52 257/688				R	F	F	F	F	US 200301
10			Ko, Cheol So	US 2002008	20020	1	Thermoelectric cooler	62/3.7 165/104.21				R	F	F	F	F	US 200200

Ready